#### **Product or Process Change Notification (PCN)**



**PCN Form Number:** 2016\_F **Date:** 07.07.2016

Company: KOA Europe GmbH Department: Product Engineering & Quality

Kaddenbusch 6 Contact: Ralf Thormählen

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**FAX:** +49 (0) 4821 89 89 80

**Affected product:** KOA's thickfilm smd series RK73.

Size: (1E=0402, 1J=0603, 2A=0805, 2B=1206)

**KOA part number:** RK73B\*, RK73H\* and RK73Z\*.

Customer part number: Several on request

Description of change: Add an outsourching plating company (Japanese manufacturer).

**Reason for the change:** To increase the plating process capacity.

**Effective Date of the** 

**change:** Immediately upon customer approval (no later by end of Dec. 2016)

**Product identification:** By lotnumber.

Quality and reliability: The electrical and mechanical performance will not be affected by this

change Please check also attached document:

Add outsourcing to the plating process.pdf

-This is a Computer Generated Document - valid without signature -

Please acknowledge the receipt of this PCN within 30 days.

Lack of acknowledgement of the PCN within 30 days constitutes acceptance of the change.

After acknowledgement, lack of additional response within a 90 days period constitutes acceptance of the change.

(according to JEDEC Standard JESD46-B)

In case of a contract, the above acknowledgement rules are replaced by the contractual agreements.

Nr. des Dokuments	Version	Geltungsbereich	Autor	Gültig ab
QM 85-03	9	KEG	Jochen Stange	18.01.2013



# Add outsourcing to the plating process in KOA China Factory

**KOA CORPORATION** 

Product Engineering
Thick Film Center
SHIMO-INA Business Field



## « Target Product»

Product name :

Thickfilm chip resistor
RK73 B · H · Z series
1E · 1J · 2A · 2B (1005 ~ 3216 size)

Target factory: KOA China Factory
 KOA ELECTRONICS(TAICANG) CO.,LTD

(Jiangsu Province, China Taicang)

## « Reason for Change»

To enhance the production capacity of KOA China factory plating process, we will add the plating outsourcing.

#### « The contents details »

We add an outsourcing in the electrode plating process in KOA China factory (KOA electronics (Taicang) Co., Ltd.) to build a stable product supply system

**[Current]** KOA China Factory only

[After] KOA China Factory

+ Outsourcing (Japan-based company)

**Concurrent** production



## The subcontractor added in the electrode plating process

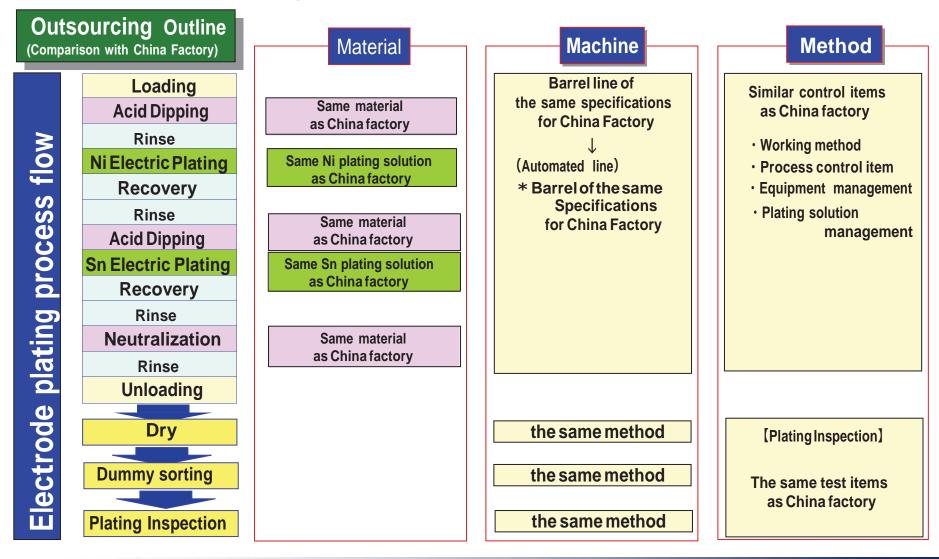
	Change point · Shift point
Machinery	It is the equipment and the same mechanism of proven equipment that is being used to KOA of plating process
Material	This is the same material as the plating process of KOA
method	This is the same method and management to KOA of plating process
Man	This is appointed as worker who was specified education and training (ISO 9001 registration factory)
Quality	Reliability test data was not a problem compared to the KOA China Factory
Location	It is located in the close location of the 40km-position to the KOA China Factory (Jiangsu Province Suzhou City)
Building	The building was built in June 2001, there is no problem in infrastructure, etc., even in the context of increased production (KOA China factory, founded in June 2000)
Logistics	We are regularly transported in dedicated vehicles between KOA China factory and Outsourcing

## [4] Confirmation of the change point



KOA

The electrode plating of the outsourced factory has been deployed in China factory on the basis of the cultivated plating technology from Japan. There is a processing performance to same degree as KOA for 14 years. In addition, there is already a delivery record of 5 years as outsourcing electrode plating company to customers that have gotten approval.



[5] Confirmation of plating quality (1)

Confidential

KOA

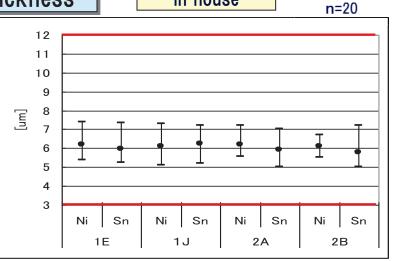


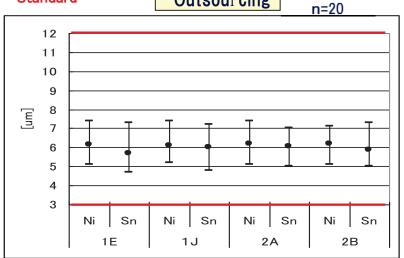
In-house

- Standard

Outsourcing

Standard:  $3 \sim 12 \mu \text{ m}$ 





This is to determine that there is no problem no difference compared to the current

n=20

2.Solderability

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Standard:
Solder-covered is that more than 95%

				11-20
	1E	1 J	2A	2B
1	OK	OK	OK	OK
2	OK	OK	OK	OK
3	OK	OK	OK	OK
4	OK	OK	OK	OK
5	OK	OK	OK	OK
6	OK	OK	OK	OK
7	OK	OK	OK	OK
8	OK	OK	OK	OK
9	OK	OK	OK	OK
10	OK	OK	OK	OK
11	OK	OK	OK	OK
12	OK	OK	OK	OK
13	OK	OK	OK	OK
14	OK	OK	OK	OK
15	OK	OK	OK	OK
16	OK	OK	OK	OK
17	OK	OK	OK	OK
18	OK	OK	OK	OK
19	OK	OK	OK	OK
20	OK	OK	OK	OK

In-house

		outsour	cing	n=20
	1 E	1J	2A	2B
1	OK	OK	OK	OK
2	OK	OK	OK	OK
3	OK	OK	OK	OK
4	OK	OK	OK	OK
5	OK	OK	OK	OK
6	OK	OK	OK	OK
7	OK	OK	OK	OK
8	OK	OK	OK	OK
9	OK	OK	OK	OK
10	OK	OK	OK	OK
11	OK	OK	OK	OK
12	OK	OK	OK	OK
13	OK	OK	OK	OK
14	OK	OK	OK	OK
15	OK	OK	OK	OK
16	OK	OK	OK	OK
17	OK	OK	OK	OK
18	OK	OK	OK	OK
19	OK	OK	OK	OK
20	OK	OK	OK	OK

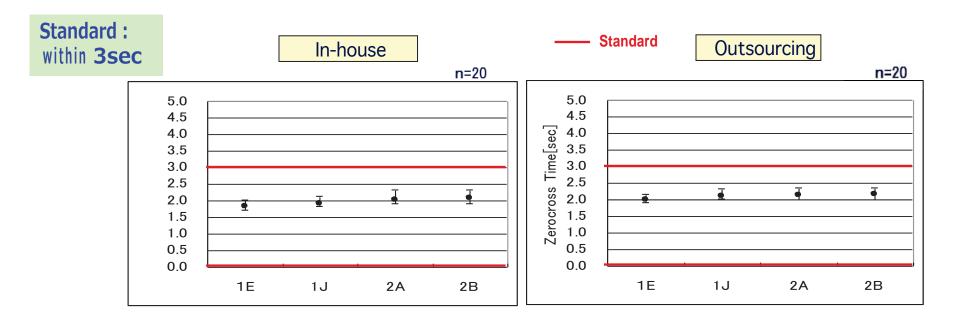
## [5] Confirmation of plating quality 2



### 2. Solderability② (Quick heating method-Judge by zerocross time)

	Condition	Methods	(,	quick heating method (Judge by zerocross time)		Within 3 seconds
		Test temp.	245℃	Sn – 3 A g – 0. 5 C u	ŭ	

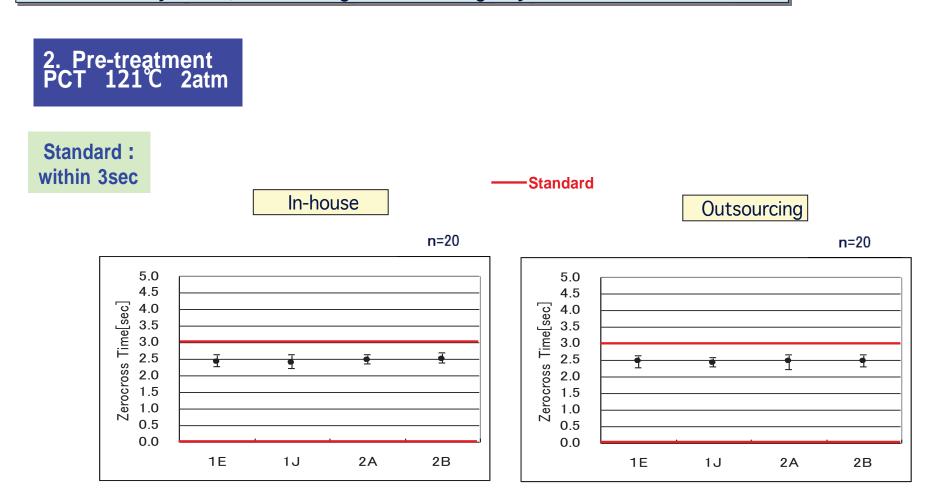
#### 1.No Pre-treatment



## [5] Confirmation of plating quality 2



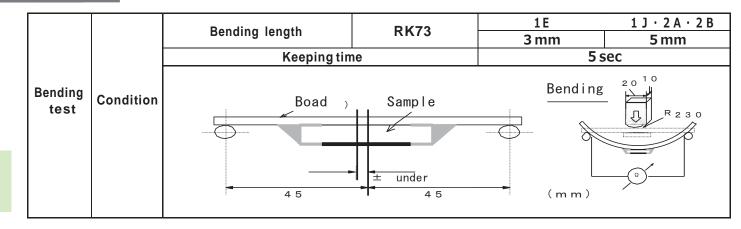
2. Solderability② (Quick heating method-Judge by zerocross time)



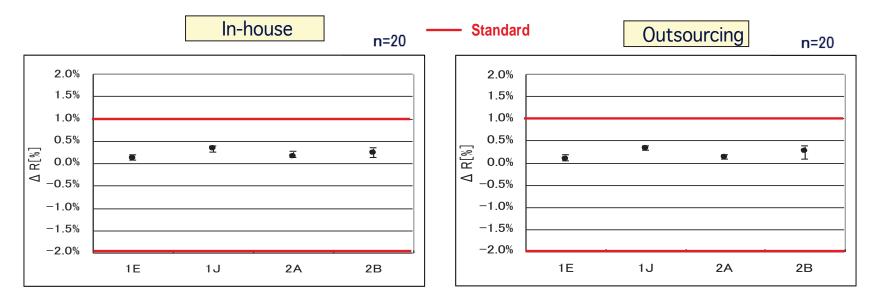
## [5] Confirmation of plating quality ③



#### 3.Bending strength



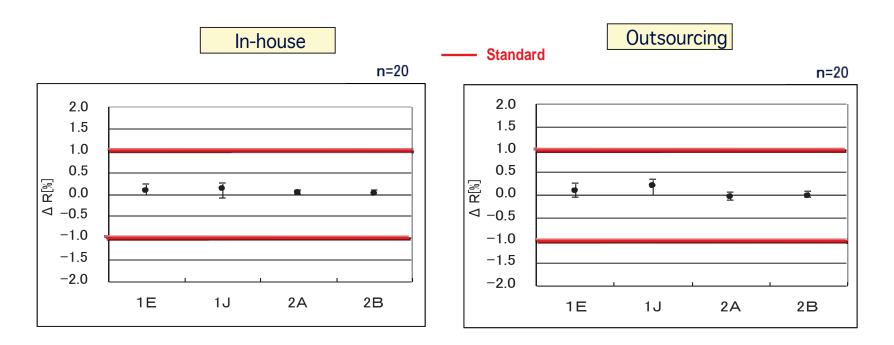
Standard: within ±1%





#### 4.Solderheat

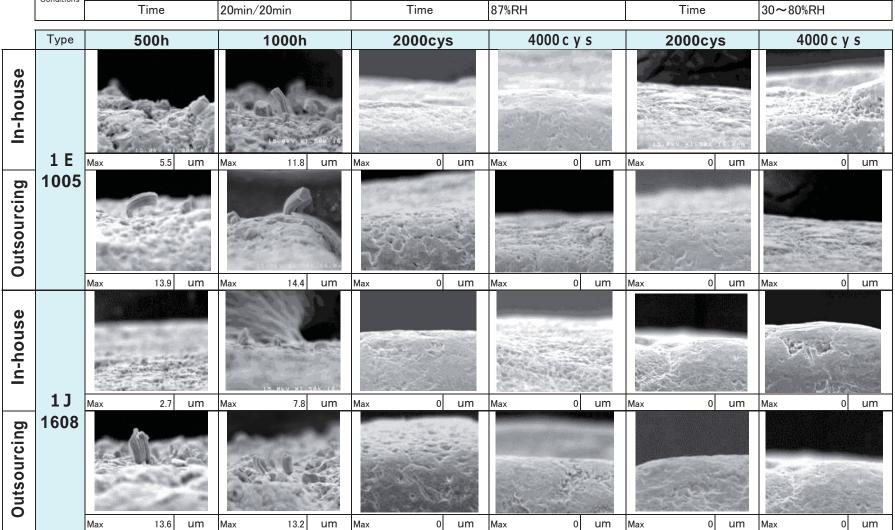
Condition	260°C	10sec		
Judgment	ΔR≦±1% (1	0R≦⊿R≦1M)		





### 5.Whisker

ITEM	Temperature cycle		High Temperature High Humidity Exposure		Ambient storage		
Conditions	Temperature	-40/85°C	Temperature	60°C	Temperature	20~25°C	
	Time	20min/20min	Time	87%RH	Time	30∼80%RH	



## [5] Confirmation of plating quality (5)



	ITEM	Temperature cycle		High Temperature High Humidity Exposure		Ambien	Ambient storage	
	Conditions	Temperature	-40/85°C	Temperature	60°C	Temperature	20~25°C	
	Condicions	Time	20min/20min	Time	87%RH	Time	30~80%RH	
	Туре	500h	1000h	2000cys	4000 c y s	2000cys	4000 c y s	
In-house	2 A	Max 4.3 um	Max 4.8 um	Max 0 um	Max 0 um	Max 0 um	Max 0 um	
Outsourcing	2125							
ln-house	2 B	Max 12.8 um  Max 0 um	Max 17.1 um  Max 10.5 um	Max 0 um	Max 0 um	Max 0 um	Max 0 um	
Outsourcing	3216		15.0×V ×1.56k' i Max 12.4 um	Max 0 um	Max 0 um	Max 0 um	Max 0 um	